



40V +175°C P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on) Max	ID MAX $T_A = +25^{\circ}C$	
40\/	11mΩ @ V _{GS} = -10V	-11A	
-40V	19mΩ @ V _{GS} = -4.5V	-8.5A	

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance R_{DS(ON)} yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- DC-DC converters
- · Power-management functions
- Analog switches

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

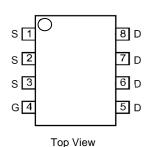
https://www.diodes.com/quality/product-definitions/

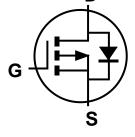
Mechanical Data

- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Top View





Equivalent Circuit

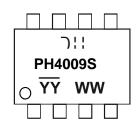
Ordering Information (Note 4)

Part Number	Paakaga	Packing		
	Fackage	Qty.	Carrier	
DMPH4009SSS-13	SO-8	2,500	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking
PH4009S= Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 23 = 2023)
WW = Week (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	-40	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = -10V	lo	-11 -7.5	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-119	Α		
Maximum Body Diode Continuous Current (Note 6)			Is	-11	Α
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)			Ism	-119	Α
Avalanche Current, L = 1mH			las	-25.7	Α
Avalanche Energy, L = 1mH			E _{AS}	330	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	R _θ JA	79	°C/W
Total Power Dissipation (Note 6)	P _D	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	R _θ JA	58.5	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

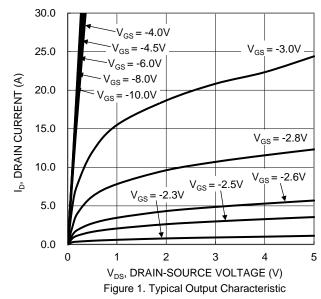
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	-40	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	-1	μΑ	V _{DS} = -40V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	-1.0	_	-2.5	٧	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Descou		7	11	mΩ	$V_{GS} = -10V, I_{D} = -9.8A$	
Static Drain-Source On-Resistance	RDS(ON)		9.5	19	11122	$V_{GS} = -4.5V$, $I_{D} = -9.8A$	
Diode Forward Voltage	V_{SD}		-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		5697	_		V _{DS} = -20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss		534	_	pF		
Reverse Transfer Capacitance	Crss	_	408	_			
Gate Resistance	Rg		7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg		53	_			
Total Gate Charge (V _{GS} = -10V)	Q_g		112	_	nC	Vps = -20V. Ip = -9.8A	
Gate-Source Charge	Qgs		20	_	IIC	VDS = -20V, ID = -9.8A	
Gate-Drain Charge	Q_{gd}	_	18	_			
Turn-On Delay Time	t _{D(ON)}		11.5	_			
Turn-On Rise Time	t _R	_	41	_		$V_{GS} = -10V$, $V_{DD} = -20V$, $R_{G} = 2\Omega$, $I_{D} = -9.8A$	
Turn-Off Delay Time	tD(OFF)	_	146	_	ns		
Turn-Off Fall Time	tF		165	_			
Reverse Recovery Time	trr	_	27	_	ns	$I_F = -9.8A$, $di/dt = -100A/\mu s$	
Reverse Recovery Charge	Q _{RR}	_	22	_	nC	I _F = -9.8A, di/dt = -100A/μs	

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.

DMPH4009SSS





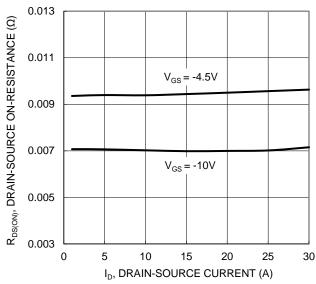


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

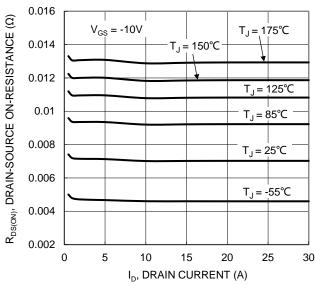


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

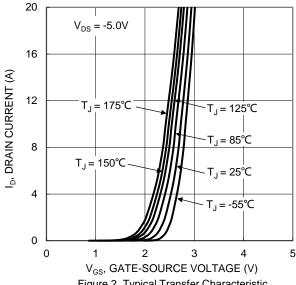


Figure 2. Typical Transfer Characteristic

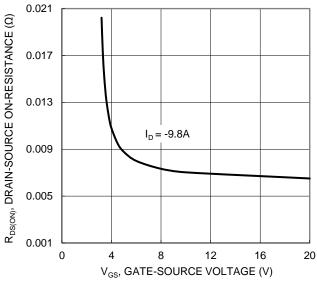


Figure 4. Typical Transfer Characteristic

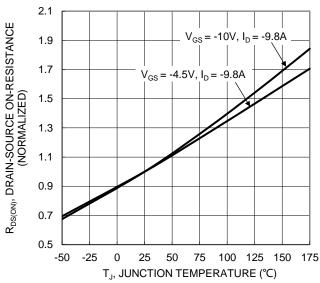


Figure 6. On-Resistance Variation with Junction Temperature





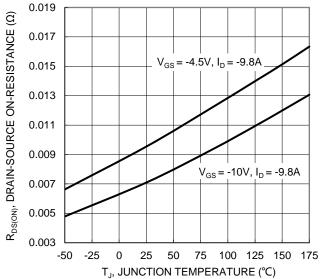


Figure 7. On-Resistance Variation with Junction Temperature

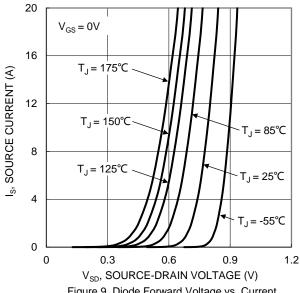


Figure 9. Diode Forward Voltage vs. Current

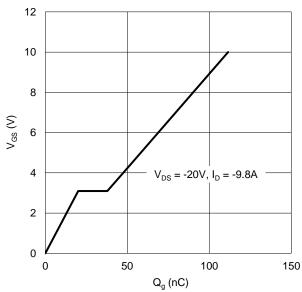


Figure 11. Gate Charge

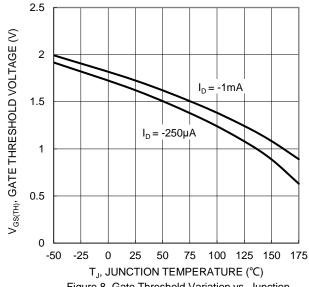
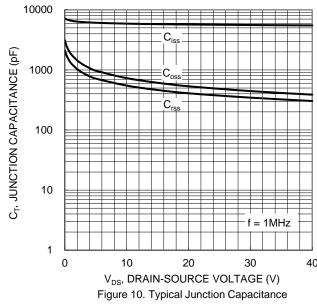
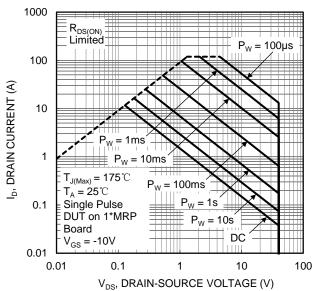


Figure 8. Gate Threshold Variation vs. Junction Temperature





September 2023



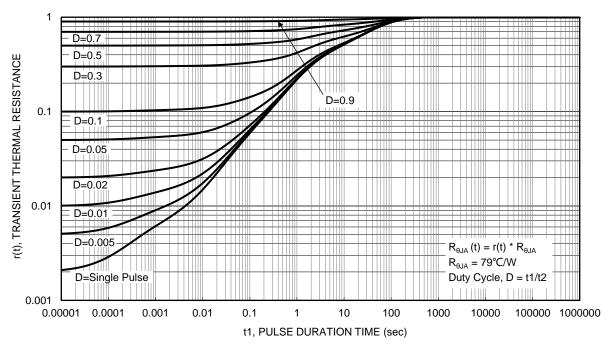
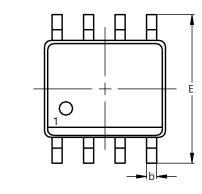


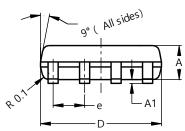
Figure 13. Transient Thermal Resistance

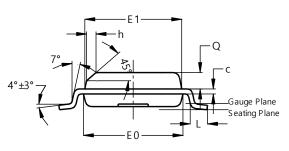


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.







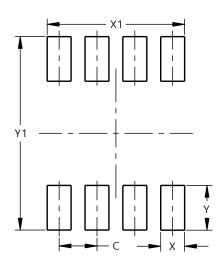
SO-8

SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
C	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h			0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)		
С	1.27		
Х	0.802		
X1	4.612		
Y	1.505		
Y1	6.50		



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